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Old Company Name in Catalogs and Other Documents

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April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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HD74LV244A

Octal Buffers / Drivers with 3-state Outputs

REJ03D0328-0300Z
 (Previous ADE-205-246A (Z))
 Rev.3.00
 Jun. 24, 2004

Description

The HD74LV244A has eight line drivers with three-state outputs in a 20-pin package. Four non-inverters are included in one circuit. Each circuit can be independently controlled by the enable signal $\overline{1OE}$ or $\overline{2OE}$, which enables outputs when receiving a low-level signal. Low-voltage operation is suitable for battery-powered products (e.g., notebook computers), and the low-power consumption extends the battery life.

Features

- $V_{CC} = 2.0\text{ V}$ to 5.5 V operation
- All inputs $V_{IH}(\text{Max.}) = 5.5\text{ V}$ ($@V_{CC} = 0\text{ V}$ to 5.5 V)
- All outputs $V_O(\text{Max.}) = 5.5\text{ V}$ ($@V_{CC} = 0\text{ V}$)
- Typical V_{OL} ground bounce $< 0.8\text{ V}$ ($@V_{CC} = 3.3\text{ V}$, $T_a = 25^\circ\text{C}$)
- Typical V_{OH} undershoot $> 2.3\text{ V}$ ($@V_{CC} = 3.3\text{ V}$, $T_a = 25^\circ\text{C}$)
- Output current $\pm 8\text{ mA}$ ($@V_{CC} = 3.0\text{ V}$ to 3.6 V), $\pm 16\text{ mA}$ ($@V_{CC} = 4.5\text{ V}$ to 5.5 V)
- Ordering Information

| Part Name | Package Type | Package Code | Package Abbreviation | Taping Abbreviation (Quantity) |
|----------------|--------------------|--------------|----------------------|--------------------------------|
| HD74LV244AFPEL | SOP-20 pin (JEITA) | FP-20DAV | FP | EL (2,000 pcs/reel) |
| HD74LV244ARPEL | SOP-20 pin (JEDEC) | FP-20DBV | RP | EL (1,000 pcs/reel) |
| HD74LV244ATELL | TSSOP-20 pin | TTP-20DAV | T | ELL (2,000 pcs/reel) |

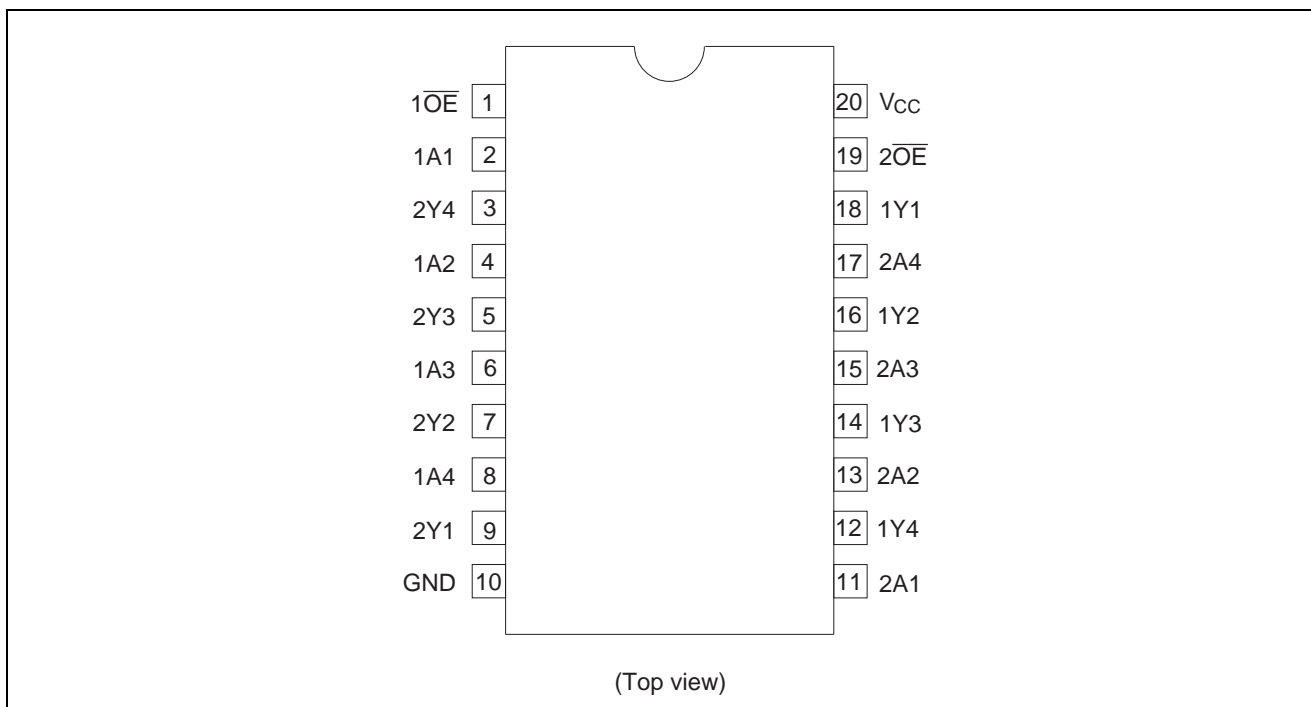
Note: Please consult the sales office for the above package availability.

Function Table

| Inputs | | | Output Y |
|-----------------|---|--|----------|
| \overline{OE} | A | | |
| L | H | | H |
| L | L | | L |
| H | X | | Z |

Note: H: High level
 L: Low level
 X: Immaterial
 Z: High impedance

Pin Arrangement



Absolute Maximum Ratings

| Item | Symbol | Ratings | Unit | Conditions |
|--|-----------------------|---------------------------------------|------------------|---|
| Supply voltage range | V_{CC} | -0.5 to 7.0 | V | |
| Input voltage range*1 | V_I | -0.5 to 7.0 | V | |
| Output voltage range*1, *2 | V_O | -0.5 to $V_{CC} + 0.5$ -0.5 to 7.0 | V | Output: H or L V_{CC} : OFF or Output: Z |
| Input clamp current | I_{IK} | -20 | mA | $V_I < 0$ |
| Output clamp current | I_{OK} | ± 50 | mA | $V_O < 0$ or $V_O > V_{CC}$ |
| Continuous output current | I_O | ± 35 | mA | $V_O = 0$ to V_{CC} |
| Continuous current through V_{CC} or GND | I_{CC} or I_{GND} | ± 70 | mA | |
| Maximum power dissipation at $T_a = 25^\circ\text{C}$ (in still air)*3 | P_T | 835 757 | mW | SOP TSSOP |
| Storage temperature | T_{stg} | -65 to 150 | $^\circ\text{C}$ | |

Notes: The absolute maximum ratings are values, which must not be individually be exceeded, and furthermore, no two of which may be realized at the same time.

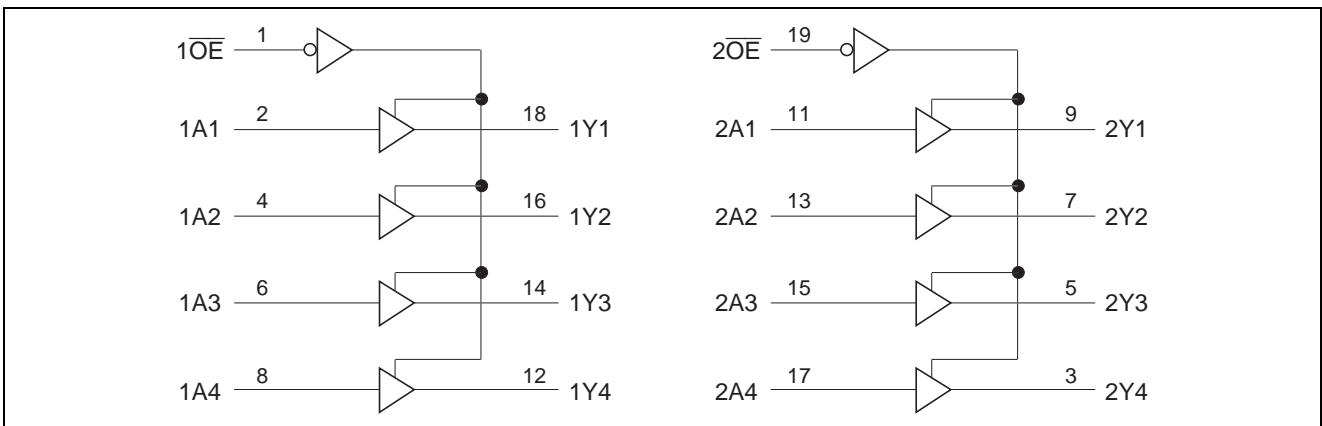
1. The input and output voltage ratings may be exceeded even if the input and output clamp-current ratings are observed.
2. This value is limited to 5.5 V maximum.
3. The data above are measured by ΔV_{BE} method mounting on glass epoxy board (40 × 40 × 1.6 mm) with 10% of wiring density.

Recommended Operating Conditions

| Item | Symbol | Min | Max | Unit | Conditions |
|------------------------------------|-----------------------|-----|----------|-------------|----------------------------------|
| Supply voltage range | V_{CC} | 2.0 | 5.5 | V | |
| Input voltage range | V_I | 0 | 5.5 | V | |
| Output voltage range | V_O | 0 | V_{CC} | V | H or L |
| | | 0 | 5.5 | | High impedance state |
| Output current | I_{OH} | — | -50 | μA | $V_{CC} = 2.0 V$ |
| | | — | -2 | mA | $V_{CC} = 2.3 \text{ to } 2.7 V$ |
| | | — | -8 | | $V_{CC} = 3.0 \text{ to } 3.6 V$ |
| | | — | -16 | | $V_{CC} = 4.5 \text{ to } 5.5 V$ |
| | I_{OL} | — | 50 | μA | $V_{CC} = 2.0 V$ |
| | | — | 2 | mA | $V_{CC} = 2.3 \text{ to } 2.7 V$ |
| | | — | 8 | | $V_{CC} = 3.0 \text{ to } 3.6 V$ |
| | | — | 16 | | $V_{CC} = 4.5 \text{ to } 5.5 V$ |
| Input transition rise or fall rate | $\Delta t / \Delta v$ | 0 | 200 | ns/V | $V_{CC} = 2.3 \text{ to } 2.7 V$ |
| | | 0 | 100 | | $V_{CC} = 3.0 \text{ to } 3.6 V$ |
| | | 0 | 20 | | $V_{CC} = 4.5 \text{ to } 5.5 V$ |
| Operating free-air temperature | T_a | -40 | 85 | $^{\circ}C$ | |

Note: Unused or floating inputs must be held high or low.

Logic Diagram



DC Electrical Characteristics

Ta = -40 to 85°C

| Item | Symbol | V _{CC} (V) | Min | Typ | Max | Unit | Test Conditions | | |
|--------------------------|--------------------------|---------------------|-----------------------|-----|-----------------------|------|--|----|---|
| Input voltage | V _{IH} | 2.0 | 1.5 | — | — | V | | | |
| | | 2.3 to 2.7 | V _{CC} × 0.7 | — | — | | | | |
| | | 3.0 to 3.6 | V _{CC} × 0.7 | — | — | | | | |
| | | 4.5 to 5.5 | V _{CC} × 0.7 | — | — | | | | |
| | V _{IL} | 2.0 | — | — | 0.5 | | | | |
| | | 2.3 to 2.7 | — | — | V _{CC} × 0.3 | | | | |
| | | 3.0 to 3.6 | — | — | V _{CC} × 0.3 | | | | |
| | | 4.5 to 5.5 | — | — | V _{CC} × 0.3 | | | | |
| Output voltage | V _{OH} | Min to Max | V _{CC} - 0.1 | — | — | V | I _{OH} = -50 μA | | |
| | | 2.3 | 2.0 | — | — | | I _{OH} = -2 mA | | |
| | | 3.0 | 2.48 | — | — | | I _{OH} = -8 mA | | |
| | | 4.5 | 3.8 | — | — | | I _{OH} = -16 mA | | |
| | V _{OL} | Min to Max | — | — | 0.1 | | I _{OL} = 50 μA | | |
| | | 2.3 | — | — | 0.4 | | I _{OL} = 2 mA | | |
| | | 3.0 | — | — | 0.44 | | I _{OL} = 8 mA | | |
| | | 4.5 | — | — | 0.55 | | I _{OL} = 16 mA | | |
| | Input current | I _{IN} | 0 to 5.5 | — | — | | ±1 | μA | V _{IN} = 5.5 V or GND |
| | Off-state output current | I _{OZ} | 5.5 | — | — | | ±5 | μA | V _O = V _{CC} or GND |
| Quiescent supply current | I _{CC} | 5.5 | — | — | 20 | μA | V _{IN} = V _{CC} or GND, I _O = 0 | | |
| Output leakage current | I _{OFF} | 0 | — | — | 5 | μA | V _I or V _O = 0 V to 5.5 V | | |
| Input capacitance | C _{IN} | 3.3 | — | 2.3 | — | pF | V _I = V _{CC} or GND | | |

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

V_{CC} = 2.5 ± 0.2 V

| Item | Symbol | Ta = 25°C | | | Ta = -40 to 85°C | | Unit | Test Conditions | FROM (Input) | TO (Output) |
|------------------------|------------------|-----------|------|------|------------------|------|------|------------------------|-----------------|-------------|
| | | Min | Typ | Max | Min | Max | | | | |
| Propagation delay time | t _{PLH} | — | 7.5 | 12.5 | 1.0 | 15.0 | ns | C _L = 15 pF | A | Y |
| | t _{PHL} | — | 9.5 | 15.3 | 1.0 | 18.0 | | C _L = 50 pF | | |
| Enable time | t _{ZH} | — | 8.9 | 14.6 | 1.0 | 17.0 | ns | C _L = 15 pF | \overline{OE} | Y |
| | t _{ZL} | — | 10.8 | 17.8 | 1.0 | 21.0 | | C _L = 50 pF | | |
| Disable time | t _{HZ} | — | 9.1 | 14.1 | 1.0 | 16.0 | ns | C _L = 15 pF | \overline{OE} | Y |
| | t _{LZ} | — | 13.4 | 19.2 | 1.0 | 21.0 | | C _L = 50 pF | | |

V_{CC} = 3.3 ± 0.3 V

| Item | Symbol | Ta = 25°C | | | Ta = -40 to 85°C | | Unit | Test Conditions | FROM (Input) | TO (Output) |
|------------------------|------------------|-----------|------|------|------------------|------|------|------------------------|-----------------|-------------|
| | | Min | Typ | Max | Min | Max | | | | |
| Propagation delay time | t _{PLH} | — | 5.4 | 8.4 | 1.0 | 10.0 | ns | C _L = 15 pF | A | Y |
| | t _{PHL} | — | 6.8 | 11.9 | 1.0 | 13.5 | | C _L = 50 pF | | |
| Enable time | t _{ZH} | — | 6.3 | 10.6 | 1.0 | 12.5 | ns | C _L = 15 pF | \overline{OE} | Y |
| | t _{ZL} | — | 7.8 | 14.1 | 1.0 | 16.0 | | C _L = 50 pF | | |
| Disable time | t _{HZ} | — | 7.6 | 11.7 | 1.0 | 13.0 | ns | C _L = 15 pF | \overline{OE} | Y |
| | t _{LZ} | — | 11.0 | 16.0 | 1.0 | 18.0 | | C _L = 50 pF | | |

V_{CC} = 5.0 ± 0.5 V

| Item | Symbol | Ta = 25°C | | | Ta = -40 to 85°C | | Unit | Test Conditions | FROM (Input) | TO (Output) |
|------------------------|------------------|-----------|-----|------|------------------|------|------|------------------------|-----------------|-------------|
| | | Min | Typ | Max | Min | Max | | | | |
| Propagation delay time | t _{PLH} | — | 3.9 | 5.5 | 1.0 | 6.5 | ns | C _L = 15 pF | A | Y |
| | t _{PHL} | — | 4.9 | 7.5 | 1.0 | 8.5 | | C _L = 50 pF | | |
| Enable time | t _{ZH} | — | 4.5 | 7.3 | 1.0 | 8.5 | ns | C _L = 15 pF | \overline{OE} | Y |
| | t _{ZL} | — | 5.6 | 9.3 | 1.0 | 10.5 | | C _L = 50 pF | | |
| Disable time | t _{HZ} | — | 6.5 | 12.2 | 1.0 | 13.5 | ns | C _L = 15 pF | \overline{OE} | Y |
| | t _{LZ} | — | 8.8 | 14.2 | 1.0 | 15.5 | | C _L = 50 pF | | |

Output-skew characteristics

C_L = 50 pF

| Item | Symbol | V _{CC} (V) | Ta = 25°C | | Ta = -40 to 85°C | | Unit |
|-------------|--------------------|---------------------|-----------|-----|------------------|-----|------|
| | | | Min | Max | Min | Max | |
| Output skew | t _{sk(O)} | 2.3 to 2.7 | — | 2.0 | — | 2.0 | ns |
| | | 3.0 to 3.6 | — | 1.5 | — | 1.5 | |
| | | 4.5 to 5.5 | — | 1.0 | — | 1.0 | |

Note: Skew between any outputs of the same package switching in the same direction. This parameter is warranted but not production tested.

Operating Characteristics

$C_L = 50 \text{ pF}$

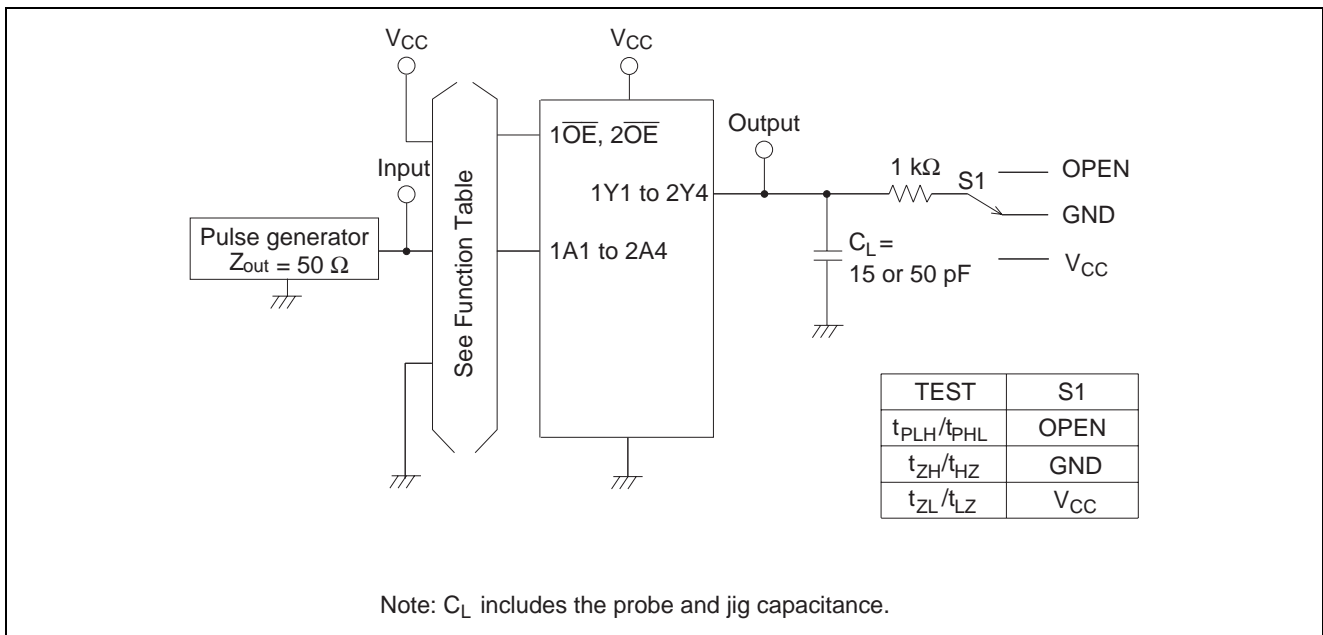
| Item | Symbol | V_{CC} (V) | $T_a = 25^\circ\text{C}$ | | | Unit | Test Conditions |
|-------------------------------|----------|--------------|--------------------------|------|-----|------|----------------------|
| | | | Min | Typ | Max | | |
| Power dissipation capacitance | C_{PD} | 3.3 | — | 14.0 | — | pF | $f = 10 \text{ MHz}$ |
| | | 5.0 | — | 16.0 | — | | |

Noise Characteristics

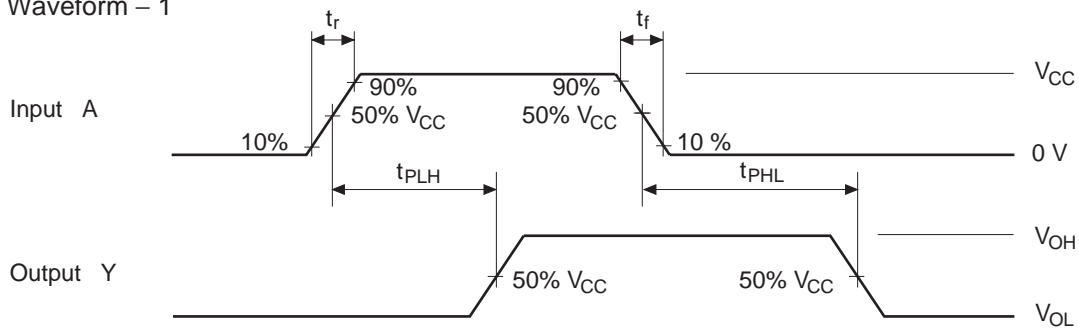
$C_L = 50 \text{ pF}$

| Item | Symbol | V_{CC} (V) | $T_a = 25^\circ\text{C}$ | | | Unit | Test Conditions |
|--|-------------|--------------|--------------------------|------|------|------|-----------------|
| | | | Min | Typ | Max | | |
| Quiet output, maximum dynamic V_{OL} | $V_{OL(P)}$ | 3.3 | — | 0.6 | 0.8 | V | |
| Quiet output, minimum dynamic V_{OL} | $V_{OL(V)}$ | 3.3 | — | -0.5 | -0.8 | V | |
| Quiet output, minimum dynamic V_{OH} | $V_{OH(V)}$ | 3.3 | — | 2.9 | — | V | |
| High-level dynamic input voltage | $V_{IH(D)}$ | 3.3 | 2.31 | — | — | V | |
| Low-level dynamic input voltage | $V_{IL(D)}$ | 3.3 | — | — | 0.99 | V | |

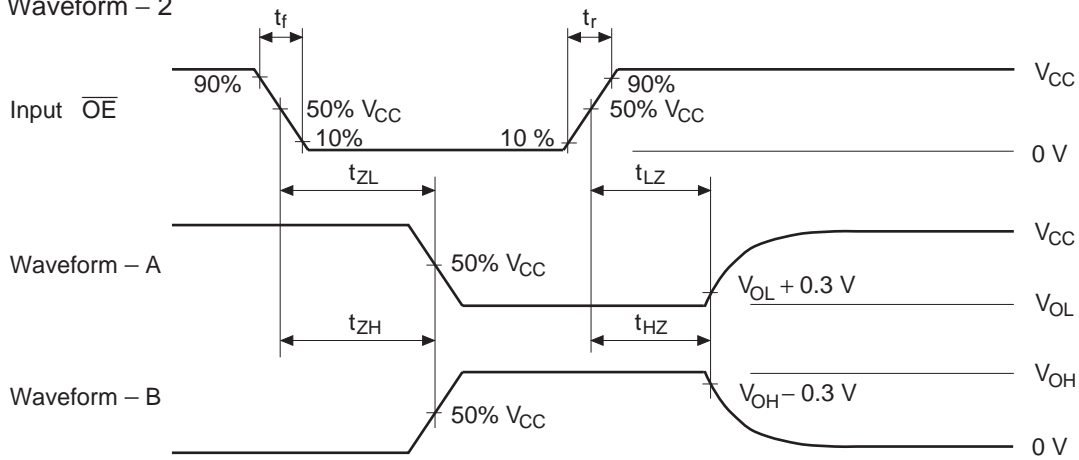
Test Circuit



• Waveform – 1

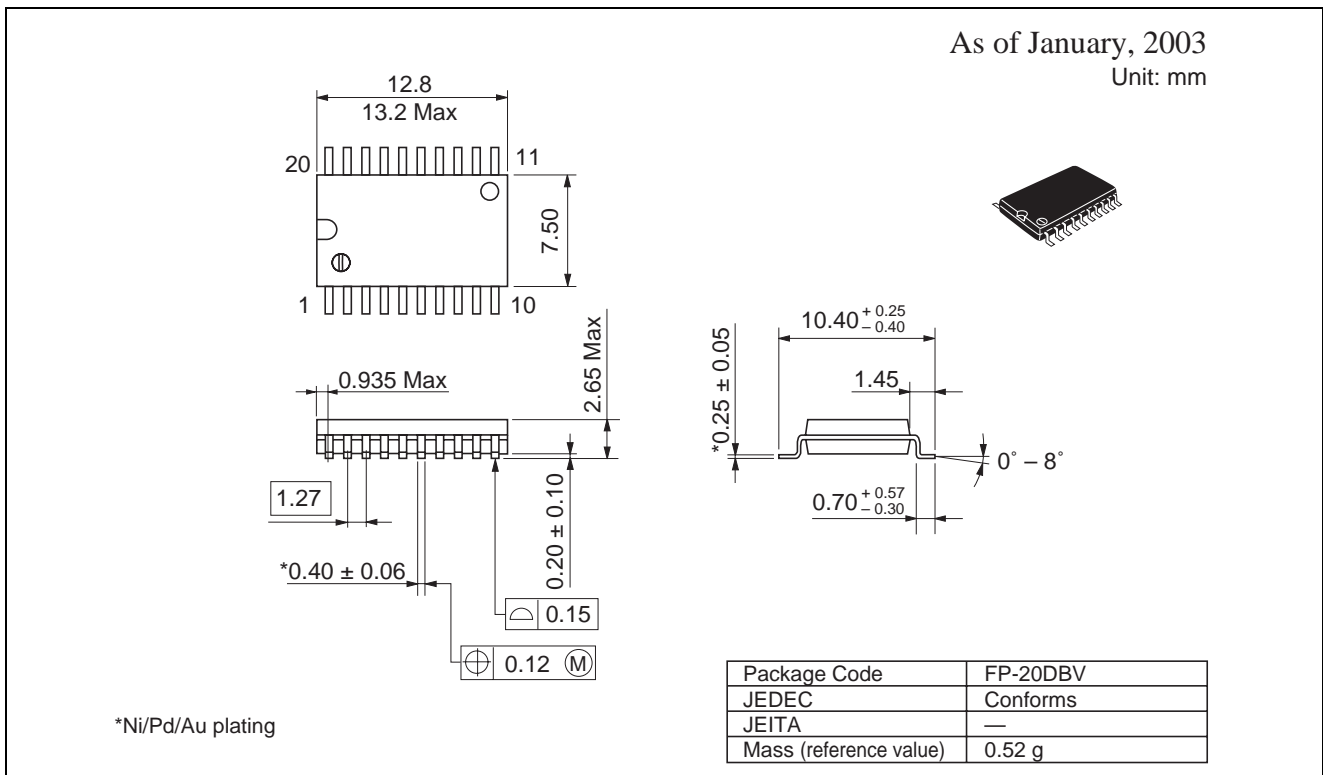
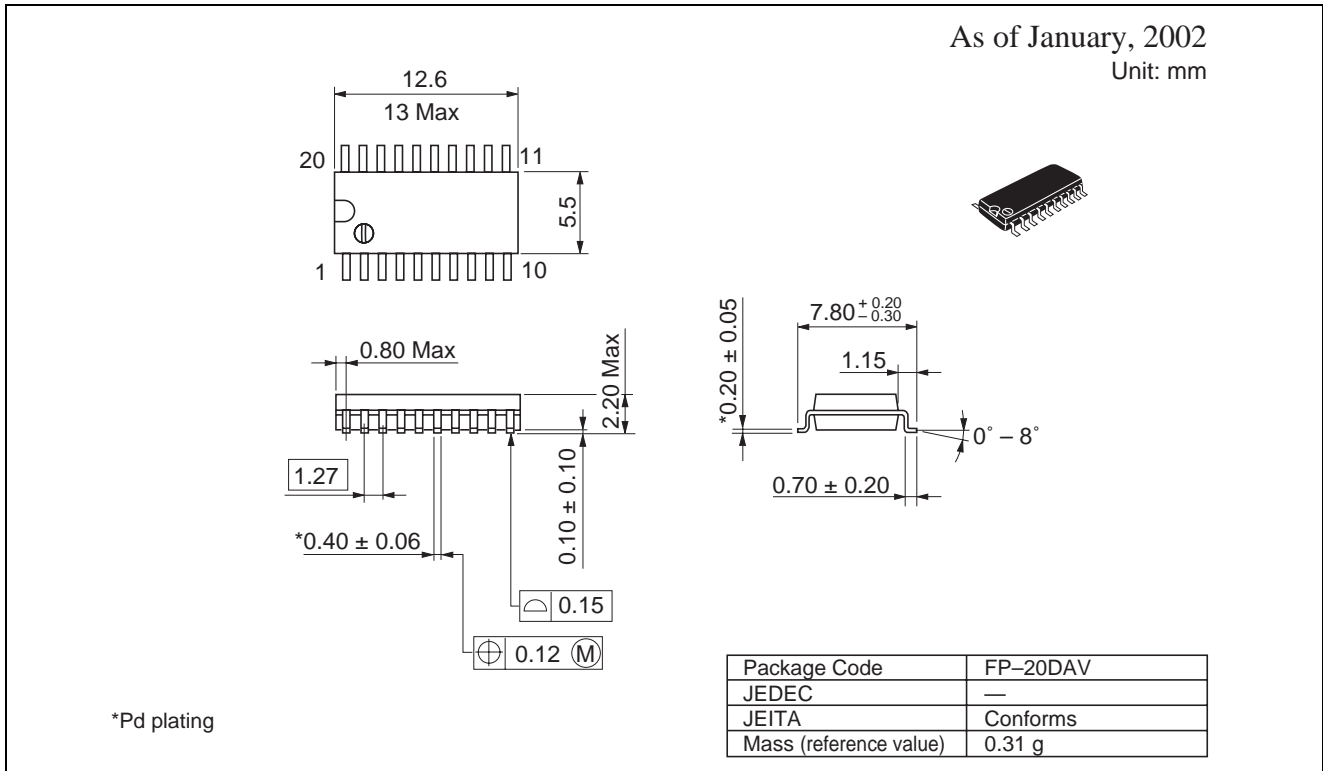


• Waveform – 2

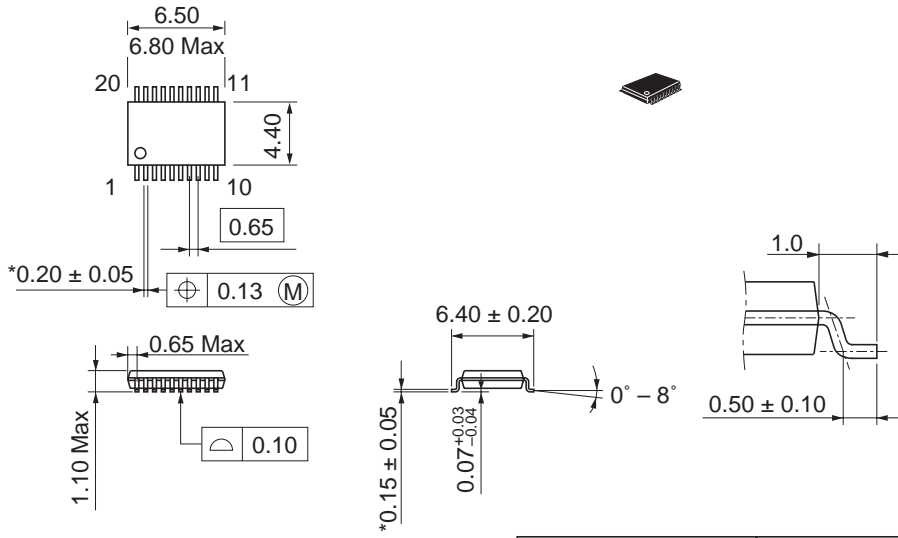


- Notes:
1. Input waveform: $PRR \leq 1 \text{ MHz}$, $Z_o = 50 \Omega$, $t_r \leq 3 \text{ ns}$, $t_f \leq 3 \text{ ns}$
 2. Waveform–A is for an output with internal conditions such that the output is low except when disabled by the output control.
 3. Waveform–B is for an output with internal conditions such that the output is high except when disabled by the output control.
 4. The output are measured one at a time with one transition per measurement..

Package Dimensions



As of January, 2002
Unit: mm



*Pd plating

| | |
|------------------------|-----------|
| Package Code | TTP-20DAV |
| JEDEC | — |
| JEITA | — |
| Mass (reference value) | 0.07 g |

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